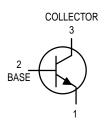
# **Switching Transistor** NPN Silicon



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCEO	15	Vdc
Collector-Emitter Voltage	VCES	40	Vdc
Collector-Base Voltage	VCBO	40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5.0	Vdc
Collector Current — Continuous — 10 μs Pulse	IC	300 500	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	625 5.0	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

# Motorola Preferred Device



**MPS3646** 

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS						
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 100 μAdc, V <sub>BE</sub> = 0)	V(BR)CES	40	_	Vdc		
Collector-Emitter Sustaining Voltage <sup>(1)</sup> (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0)	VCEO(sus)	15	_	Vdc		
Collector-Base Breakdown Voltage (I <sub>C</sub> = 100 μAdc, I <sub>E</sub> = 0)	V(BR)CBO	40	_	Vdc		
Emitter-Base Breakdown Voltage ( $I_E = 100 \mu Adc$ , $I_C = 0$ )	V(BR)EBO	5.0	_	Vdc		
Collector Cutoff Current (VCE = 20 Vdc, VBE = 0) (VCE = 20 Vdc, VBE = 0, TA = 65°C)	ICES	_ _	0.5 3.0	μAdc		

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.



# **MPS3646**

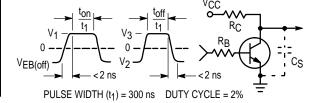
# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

	Chara	Symbol	Min	Max	Unit	
ON CHARACTER	ISTICS(1)		•		•	•
DC Current Gain		$(I_C = 30 \text{ mAdc}, V_{CE} = 0.4 \text{ Vdc})$ $(I_C = 100 \text{ mAdc}, V_{CE} = 0.5 \text{ Vdc})$ $(I_C = 300 \text{ mA}, V_{CE} = 1.0 \text{ Vdc})$	hFE	30 25 15	120 — —	_
Collector – Emitter Saturation Voltage		(I <sub>C</sub> = 30 mAdc, I <sub>B</sub> = 3.0 mAdc) (I <sub>C</sub> = 100 mAdc, I <sub>B</sub> = 10 mAdc) (I <sub>C</sub> = 300 mAdc, I <sub>B</sub> = 30 mAdc) (I <sub>C</sub> = 30 mA, I <sub>B</sub> = 3.0 mA, T <sub>A</sub> = 65°C)	VCE(sat)	_ _ _ _	0.2 0.28 0.5 0.3	Vdc
$(I_C = 100 \text{ mAdc}, I_B = 10 \text{ m})$		(I <sub>C</sub> = 30 mAdc, I <sub>B</sub> = 3.0 mAdc) (I <sub>C</sub> = 100 mAdc, I <sub>B</sub> = 10 mAdc) (I <sub>C</sub> = 300 mAdc, I <sub>B</sub> = 30 mA)	V <sub>BE</sub> (sat)	0.73 — —	0.95 1.2 1.7	Vdc
SMALL-SIGNAL	CHARACTERISTICS	3			•	
Current-Gain — Bandwidth Product (IC = 30 mAdc, V <sub>CE</sub> = 10 Vdc, f = 100 MHz)				350	_	MHz
Output Capacitance (V <sub>CB</sub> = 5.0 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)				_	5.0	pF
Input Capacitance (VEB = 0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)				_	9.0	pF
SWITCHING CHA	RACTERISTICS				•	
Turn-On Time			ton	_	18	ns
Delay Time	( $V_{CC}$ = 10 Vdc, $I_{C}$ = 300 mAdc, $I_{B1}$ = 30 mAdc) (Figure 1)		t <sub>d</sub>	_	10	ns
Rise Time			t <sub>r</sub>	_	15	ns
Turn-Off Time	(V <sub>CC</sub> = 10 Vdc, I <sub>C</sub> :	(V <sub>CC</sub> = 10 Vdc, I <sub>C</sub> = 300 mAdc, I <sub>B1</sub> = I <sub>B2</sub> = 30 mAdc)		_	28	ns
Fall Time	(Figure 1)		t <sub>f</sub>	_	15	ns
Storage Time $(V_{CC} = 10 \text{ Vdc}, I_C = 10 \text{ mAdc}, I_{B1} = I_{B2} = 10 \text{ mAdc})$ (Figure 2)		t <sub>S</sub>	_	18	ns	

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu s;$  Duty Cycle  $\leq$  2.0%.

Figure 1. Switching Time Equivalent Test Circuit

Test Condition	lc	vcc	Rs	RC	C <sub>S(max)</sub>	V <sub>BE(off)</sub>	٧1	V <sub>2</sub>	V <sub>3</sub>
	mΑ	V	Ω	Ω	pF	V	V	V	V
Α	10	3	330	270	4	-1.5	10.55	-4.15	10.70
В	10	10	580	960	4	_	_	-4.65	6.55
С	100	10	560	96	12	-2.0	6.35	-4.65	6.55



#### **CURRENT GAIN CHARACTERISTICS**

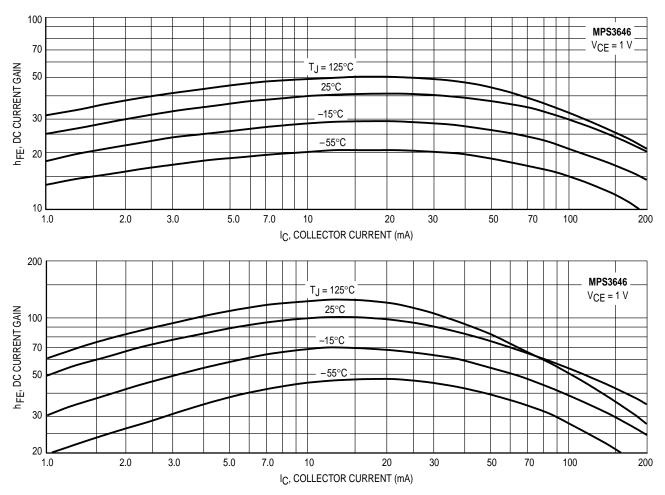


Figure 2. Minimum Current Gain

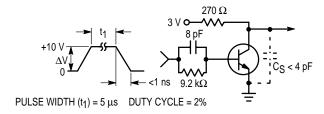


Figure 3. QT Test Circuit

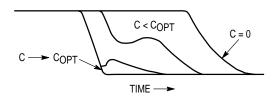


Figure 4. Turn-Off Waveform

### NOTE 1

When a transistor is held in a conductive state by a base current, IB, a charge, QS, is developed or "stored" in the transistor. QS may be written:  $Q_S = Q_1 + Q_V + Q_X$ .

Q<sub>1</sub> is the charge required to develop the required collector current. This charge is primarily a function of alpha cutoff frequency. QV is the charge required to charge the collector-base feedback capacity. Qx is excess charge resulting from overdrive, i.e., operation in saturation.

The charge required to turn a transistor "on" to the edge of saturation is the sum of Q1 and QV which is defined as the active region charge,  $Q_A$ .  $Q_A = I_{B1}t_\Gamma$  when the transistor is driven by a constant current step

(I<sub>B1</sub>) and I<sub>B1</sub>  $< < \frac{I_C}{h_{FF}}$ 

If IB were suddenly removed, the transistor would continue to conduct until Qs is removed from the active regions through an external path or through internal recombination. Since the internal recombination time is long compared to the ultimate capability of a transistor, a charge, Q<sub>T</sub>, of opposite polarity, equal in magnitude, can be stored on an external capacitor, C, to neutralize the internal charge and considerably reduce the turn-off time of the transistor. Figure 3 shows the test circuit and Figure 4 the turn-off waveform. Given QT from Figure 13, the external C for worst-case turn-off in any circuit is:  $C = Q_T/\Delta V$ , where  $\Delta V$  is defined in Figure 3.

# "ON" CONDITION CHARACTERISTICS

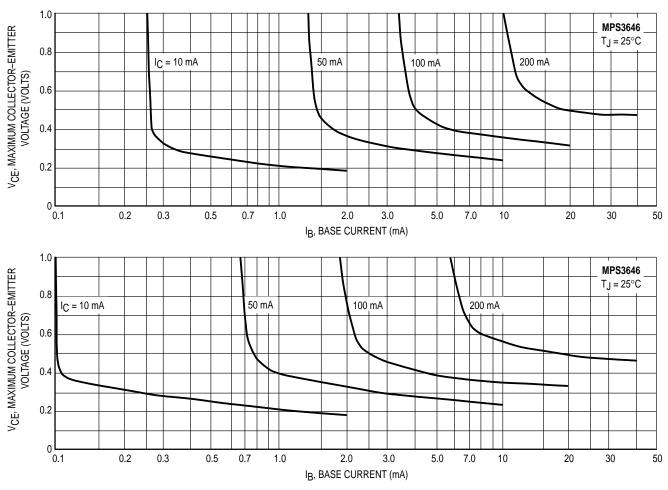
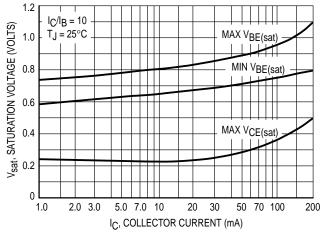
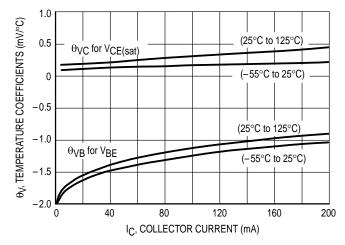


Figure 5. Collector Saturation Region



**Figure 6. Saturation Voltage Limits** 



**Figure 7. Temperature Coefficients** 

## **DYNAMIC CHARACTERISTICS**

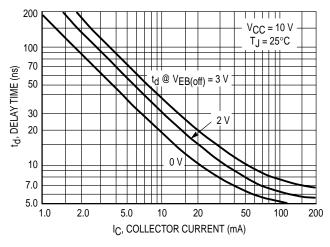
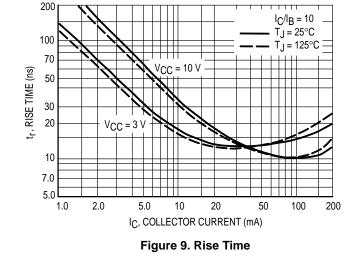


Figure 8. Delay Time



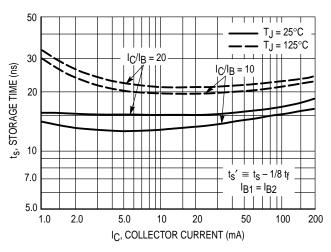


Figure 10. Storage Time

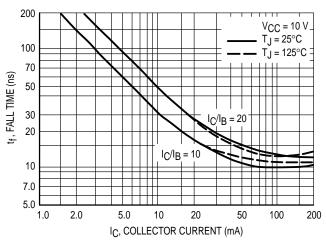


Figure 11. Fall Time

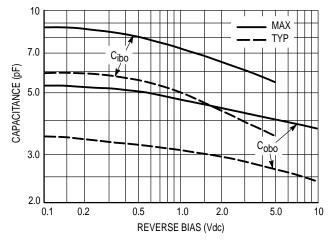


Figure 12. Junction Capacitance

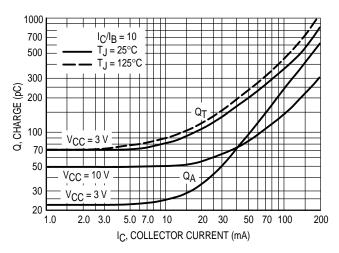
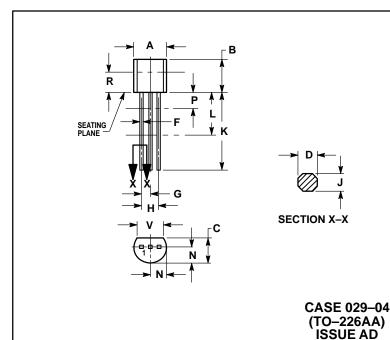


Figure 13. Maximum Charge Data

#### PACKAGE DIMENSIONS



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
  CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K
  MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.022	0.41	0.55	
F	0.016	0.019	0.41	0.48	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Р		0.100		2.54	
R	0.115		2.93		
V	0.135		3 43		

STYLE 1: PIN 1. EMITTER

BASE 3. COLLECTOR

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